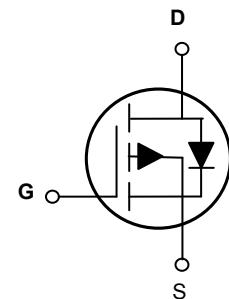
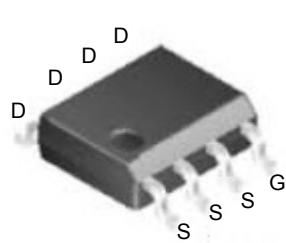


## Main Product Characteristics

$V_{(BR)DSS}$	-30V
$R_{DS(ON)}$	9.5mΩ
$I_D$	-13A



SOP-8

Schematic Diagram

## Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



## Description

The SSFQ3903 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

## Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	V
Drain Current – Continuous ( $T_C=25^\circ\text{C}$ )	$I_D$	-13	A
Drain Current – Continuous ( $T_C=100^\circ\text{C}$ )		-7.8	A
Drain Current – Pulsed <sup>1</sup>	$I_{DM}$	-52	A
Power Dissipation ( $T_C=25^\circ\text{C}$ )	$P_D$	4.2	W
Power Dissipation – Derate above 25°C		0.034	W/°C
Storage Temperature Range	$T_{STG}$	-55 to +150	°C
Operating Junction Temperature Range	$T_J$	-55 to +150	°C

## Thermal Characteristics

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance Junction to Case	$R_{JC}$	---	30	°C/W
Thermal Resistance Junction to Ambient	$R_{JA}$	---	60	°C/W

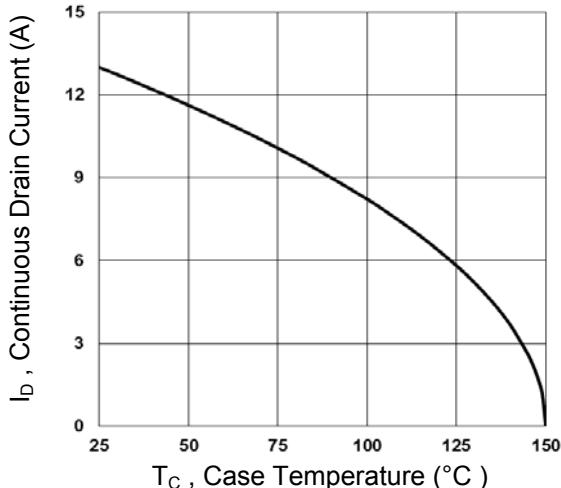
## **Electrical Characteristics** ( $T_J=25^\circ\text{C}$ unless otherwise specified)

DfUla Yhf	Gra Vc`	7cbXjhcbg	Ajb"	Hnd"	AU "	I bh
<b>CZ7\ UFUWYf]gh]Wg</b>						
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Öi^ ÄU[ ^; & ÄS^ ä ä ^ÄO^ ;^} c	Quü	XöuMÉÄXEXöuMEXÄV\NGÍ xÔ	EE	EE	EE	OE
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<b>Cb 7\ UFUWYf]gh]Wg</b>						
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V' i} ÄU} ÄÖ^  æ ÄVä ^GÉH	VäfD	XöuMÉÄXEXöuMÉÄXEXöuMÄ ÄQMÉ€OE	EE	GE	H	} Ü
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V' i} ÄU -ÄÖ^  æ ÄVä ^GÉH	Väf-D		EE	FÍ î	GE	
ÖäÄÄVä ^GÉH	V-		EE	i €	î í	
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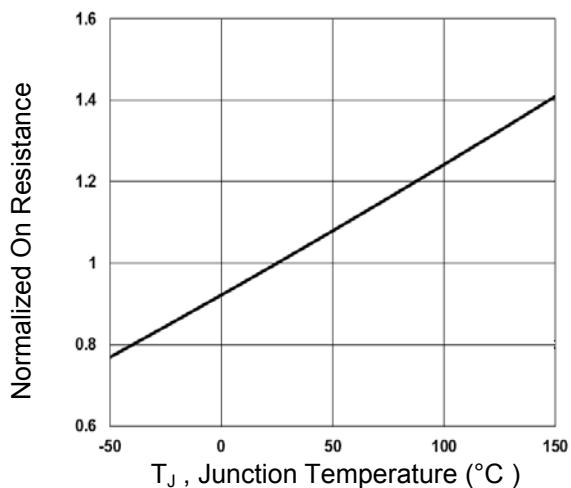
**Note:**

1. Repetitive Rating: Pulsed width limited by maximum junction temperature.
  2. The data tested by pulsed, pulse width  $\leq 300$   $\mu\text{S}$ , duty cycle  $\leq 2\%$ .
  3. Essentially independent of operating temperature.

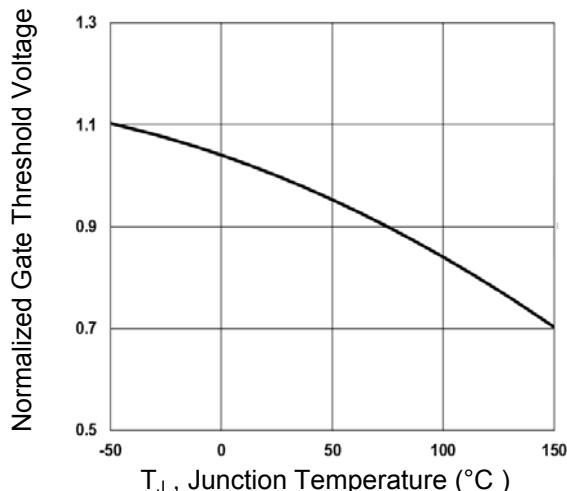
## Typical Electrical and Thermal Characteristic Curves



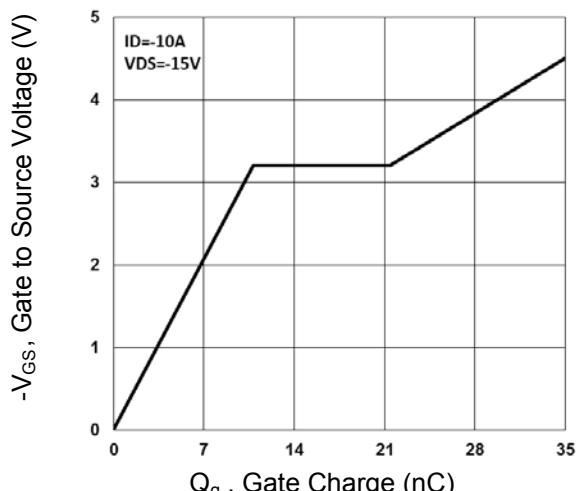
**Fig.1** Continuous Drain Current vs. T<sub>c</sub>



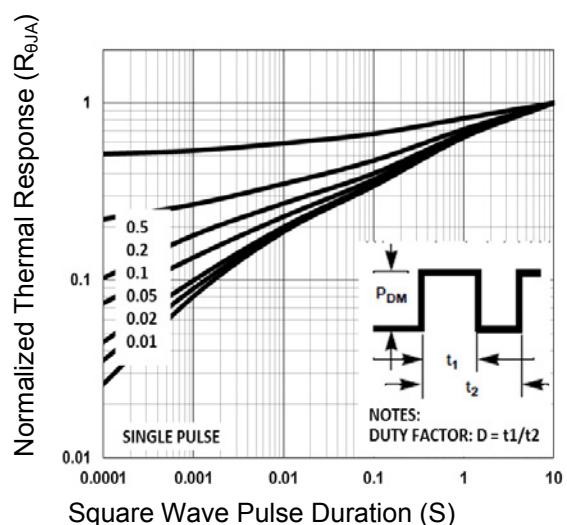
**Fig.2** Normalized R<sub>DS(ON)</sub> vs. T<sub>j</sub>



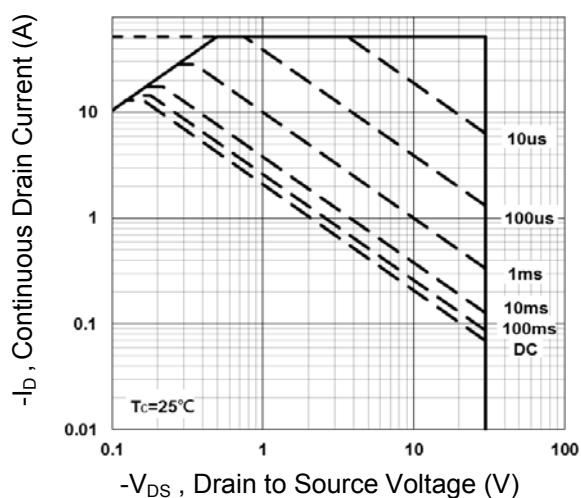
**Fig.3** Normalized V<sub>th</sub> vs. T<sub>j</sub>



**Fig.4** Gate Charge Waveform



**Fig.5** Normalized Transient Impedance



**Fig.6** Maximum Safe Operation Area

## Typical Electrical and Thermal Characteristic Curves

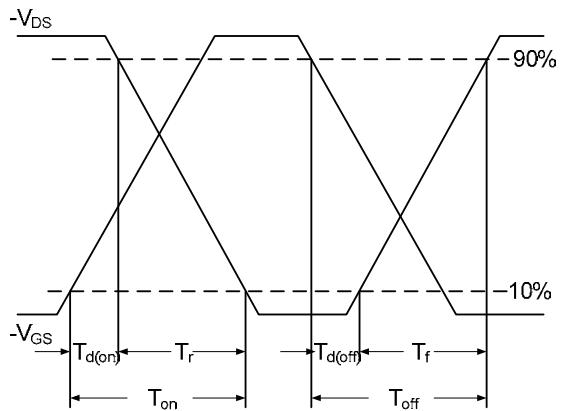


Fig.7 Switching Time Waveform

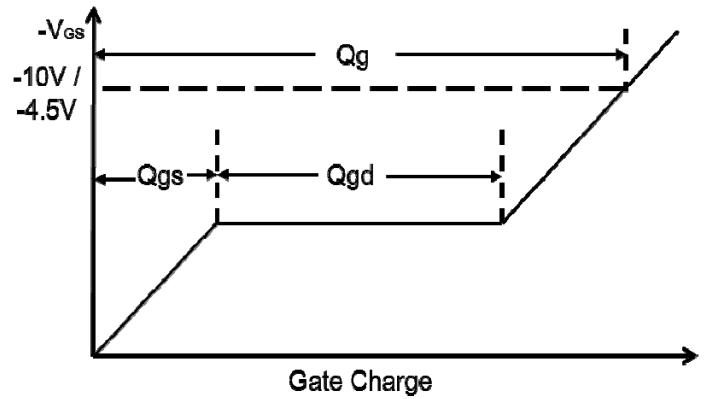
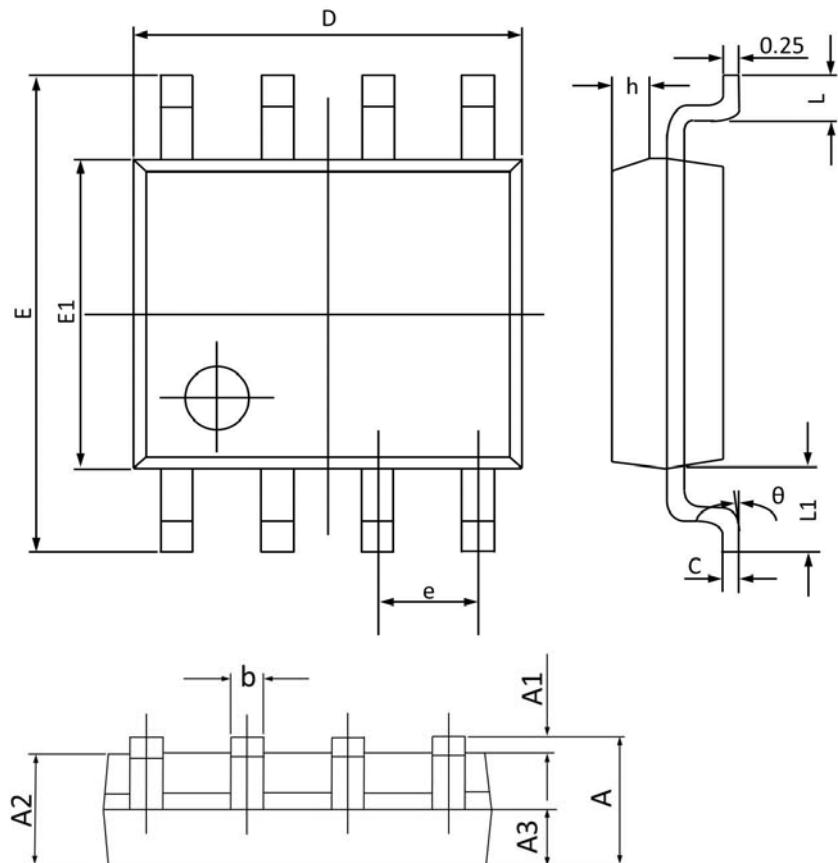


Fig.8 Gate Charge Waveform

### Package Outline Dimensions

**SOP-8**



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.068
A1	0.1	0.25	0.004	0.009
A2	1.3	1.5	0.052	0.059
A3	0.6	0.7	0.024	0.027
b	0.39	0.48	0.016	0.018
c	0.21	0.26	0.009	0.01
D	4.7	5.1	0.186	0.2
E	5.8	6.2	0.229	0.244
E1	3.7	4.1	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.25	0.5	0.01	0.019
L	0.5	0.8	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
θ	0°	8°	0°	8°